

To: Technology Unit: 3729
Facsimile Number: 703-872-9306

Total Pages Sent 4

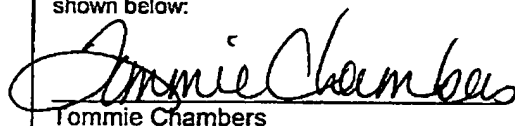
From: W. Daniel Swayze, Jr.
Texas Instruments Incorporated
Facsimile: 972-917-4418
Phone: 972-917-5633

W.D. SWAYZE
TECHNOLOGY UNIT
FEB 24 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at 703-872-9306 on the date shown below:


Tommie Chambers

February 24, 2005
Date

FACSIMILE COVER SHEET

<input checked="" type="checkbox"/> FACSIMILE COVER SHEET <input type="checkbox"/> NEW APPLICATION <input type="checkbox"/> DECLARATION (# Pages) <input type="checkbox"/> ASSIGNMENT (# Pages) <input type="checkbox"/> FORMAL DRAWINGS <input type="checkbox"/> INFORMAL DRAWINGS <input type="checkbox"/> CONTINUATION APP'N (# Pages) <input type="checkbox"/> DIVISIONAL APP'N	<input type="checkbox"/> AMENDMENT (# Pages) <input type="checkbox"/> EOT (# Month) <input type="checkbox"/> NOTICE OF APPEAL <input type="checkbox"/> APPEAL (# Pages) <input type="checkbox"/> ISSUE FEE (# Pages) <input type="checkbox"/> CHANGE IN CORRESPONDENCE <input type="checkbox"/> ADDRESS <input checked="" type="checkbox"/> RESPONSE		
NAME OF INVENTOR(S): Abbott		RECEIPT DATE & SERIAL NO.: Serial No.: 09/514,762 Filing Date: 2/28/2000	
TITLE OF INVENTION: DOUBLE SIDED FLEXIBLE CIRCUIT FOR INTEGRATED CIRCUIT PACKAGES AND METHOD OF MANUFACTURE			
TI FILE NO.: TI-26904	DEPOSIT ACCT. NO.: 20-0668		
FAXED: 02/24/2005 DUE: ATTY/SECY: WDS/ljc			

This facsimile is intended only for the use of the address named and contains legally privileged and/or confidential information. If you are not the intended recipient of this telecopy, you are hereby notified that any dissemination, distribution, copying or use of this communication is strictly prohibited. Applicable privileges are not waived by virtue of the document having been transmitted by Facsimile. Any misdirected facsimiles should be returned to the sender by mail at the address indicated on this cover sheet.

Texas Instruments Incorporated
PO Box 655474, M/S 3999
Dallas, TX 75265

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

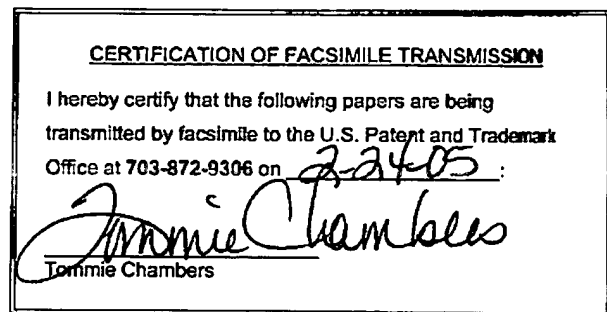
Applicant: Abbott
Serial No: 09/514,762
Filed: 2/28/2000
For: DOUBLE SIDED FLEXIBLE CIRCUIT FOR INTEGRATED CIRCUIT
PACKAGES AND METHOD OF MANUFACTURE

Docket No: TI-26904
Examiner: Chang, Rick
Art Unit: 3729

Handwritten: 2/28/2005

RESPONSE

Assistant Commissioner For Patents
Washington, DC 20231



Dear Sir:

Responsive to the Office Action mailed February 16, 2005 in connection with the above identified application, Applicants respectfully submit the following amendments and remarks.